IN THE SPECIFICATION

Please insert the following heading at page 1, prenumbered line 3:

FIELD OF THE INVENTION

Please insert the following heading at page 1, prenumbered line 16:

DISCUSSION OF THE BACKGROUND

Please insert the following heading at page 5, prenumbered line 3:

SUMMARY OF THE INVENTION

Please amend the paragraph at page 5, lines 19-24, as follows:

The subject of the invention is firstly a method ~~which consists of~~ including:

- a phase of locating at least one defect lying within the active system; and
- a phase of ablating the defect, consisting in circumscribing the latter using said laser beam.

Please insert the following heading at page 6, prenumbered line 26:

BRIEF DESCRIPTION OF THE DRAWINGS

Please insert the following heading at page 6, prenumbered line 35:

DESCRIPTION OF THE PREFERRED EMBODIMENTS